

SEMICON Japan 2010 Booth Application Form



We hereby apply for booth space at SEMICON Japan 2010. If we are accepted as an EXHIBITOR, we agree to abide by the show rules and regulations as defined in the Exhibitor Services Manual and the terms of rules and regulations set out in the Exhibition Information.

APPLICANT's authorized signature : _____ Date : _____

IMPORTANT : *To be filled-in with BLOCK LETTERS
*This APPLICATION must be returned by FAX to SEMI Japan by deadline. (FAX:+81-3-3222-5757)
Deadline : First term Monday May 31, 2010. Second term Wednesday July 7, 2010.

◆APPLICANT

Company Name						
SEMI Membership		<input type="checkbox"/> Yes or Registered as a Wholly Owned Subsidiary Member Company <input type="checkbox"/> NO (Name of the Member company: _____)				
Responsible Person		Fast name	Last name	Title/Division		
Main Contact Person		Fast name	Last name	Title/Division		
		Mailing Street Address (No P.O. Boxes)			City;	
		State;	Postal Code;	Country;		
		Phone	Fax			
Mr. Ms. Dr.						
<input type="checkbox"/> <input type="checkbox"/> <input type="checkbox"/>						
E-mail						
Contact Person In JAPAN (Unnecessary if there is no person)		Name	Title/Division			
		Address				
		Phone	Fax			
		E-mail				

※ NOTE: We mail exhibitor information only to your Contact Person in Japan, if there is one.

◆Agent

If you have appointed an agent to handle payment of exhibition fees and/or communications with SEMI Japan Office, please check the box below and register the contact person

<input type="checkbox"/> Agent will handle payment of exhibition fees. (Please issue an invoice to this agent.)
<input type="checkbox"/> Agent will handle Communication with SEMI Japan Office.

Agent Information

Company Name					
Address					
Name		Title/Division			
Phone		Fax			
E-mail					

SEMICON Japan 2010
December 1-3
Makuhari messe, Chiba Japan

◆Number of Booth / Requests (May not be fulfilled)

Total Number of Booth(s) Requested		Your Total Booth Fee (tax included)		Please refer to the Booth Fee Rates and Exhibit Category in the Exhibition Information. N.B. : Booth fee does not include decoration.
Raw Space	Booth(s)	Yen		
Booth configuration request	<input type="checkbox"/> In-line	<input type="checkbox"/> Cross aisle (4 booths or more)	<input type="checkbox"/> Block (4 booths or more)	
Prefer not to be beside				

◆Exhibit Zone (Exhibiting in 2Zones) (If you want to exhibit in 2 Zones, please check all relevant)

For visitor's convenience, exhibits will be zoned in 6 categories. Please check one, which applies. We will try our best to meet your request.

<input type="checkbox"/> Front-end Process & Parts Zone : <input type="checkbox"/> Array Design <input type="checkbox"/> Array Design Tool, Mask <input type="checkbox"/> Reticle Mfg. Equipment <input type="checkbox"/> Wafer Mfg. Equipment <input type="checkbox"/> Wafer Processing Equipment <input type="checkbox"/> Other	(Booth(s))
<input type="checkbox"/> Front-end Process related Facilities & Materials Zone : <input type="checkbox"/> Transport Robot <input type="checkbox"/> Chemical & Water <input type="checkbox"/> Gas <input type="checkbox"/> Clean-room Facilities Safety <input type="checkbox"/> Other	(Booth(s))
<input type="checkbox"/> Back-end Equipment & Parts Zone : <input type="checkbox"/> Dicer, Bonder, Logic <input type="checkbox"/> Memory <input type="checkbox"/> Linear & Mixed Signal Test Equipment <input type="checkbox"/> Packaging Equipment <input type="checkbox"/> Surface Mount Technology <input type="checkbox"/> Other	(Booth(s))
<input type="checkbox"/> Back-end Facilities & Materials Zone : <input type="checkbox"/> Handler <input type="checkbox"/> Lead frame <input type="checkbox"/> Molding Compound <input type="checkbox"/> Solder <input type="checkbox"/> Other	(Booth(s))
<input type="checkbox"/> Front-end / Back-end Combined Zone : <input type="checkbox"/> Front-end & Back-end Process Equipment, Parts, Facilities & Materials <input type="checkbox"/> Electric Design Automation	(Booth(s))
<input type="checkbox"/> Press & Publication	(Booth(s))

P a v i l i o n	<input type="checkbox"/> Emerging Technology Area	(Booth) (<input type="checkbox"/> 2m width×1m depth(Packaged-booth) <input type="checkbox"/> 2m width×2m depth <input type="checkbox"/> 3m width×3m depth) (<input type="checkbox"/> In-line <input type="checkbox"/> Block)
	<input type="checkbox"/> MEMS Technology Area	(Booth) (<input type="checkbox"/> 2m width×1m depth(Packaged-booth) <input type="checkbox"/> 2m width×2m depth <input type="checkbox"/> 3m width×3m depth) (<input type="checkbox"/> In-line <input type="checkbox"/> Block)
	<input type="checkbox"/> Nanoimprint Technology Area	(Booth) (<input type="checkbox"/> 2m width×1m depth(Packaged-booth) <input type="checkbox"/> 2m width×2m depth <input type="checkbox"/> 3m width×3m depth) (<input type="checkbox"/> In-line <input type="checkbox"/> Block)
	<input type="checkbox"/> 3-D Packaging Technology Area	(Booth) (<input type="checkbox"/> 2m width×1m depth(Packaged-booth) <input type="checkbox"/> 2m width×2m depth <input type="checkbox"/> 3m width×3m depth) (<input type="checkbox"/> In-line <input type="checkbox"/> Block)
	<input type="checkbox"/> Anti-Counterfeiting Technology Area	(Booth) (<input type="checkbox"/> 2m width×1m depth(Packaged-booth) <input type="checkbox"/> 2m width×2m depth <input type="checkbox"/> 3m width×3m depth) (<input type="checkbox"/> In-line <input type="checkbox"/> Block)
	<input type="checkbox"/> LED Technology Area	(Booth) (<input type="checkbox"/> 2m width×1m depth(Packaged-booth) <input type="checkbox"/> 2m width×2m depth <input type="checkbox"/> 3m width×3m depth) (<input type="checkbox"/> In-line <input type="checkbox"/> Block)
<input type="checkbox"/> Poster Session Area	(Booth) <input type="checkbox"/> Front-end Process & Parts Zone <input type="checkbox"/> Front-end Process related Facilities & Materials Zone <input type="checkbox"/> Back-end Zone	
<input type="checkbox"/> Discussion Area	<input type="checkbox"/> 6m width×6m depth (4 booth) <input type="checkbox"/> 9m width×6m (6 booth)	

◆For SEMI Use Only

Day received	Receipt number	Receipt stamp

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